



**GP**  
**ELECTRONICS**

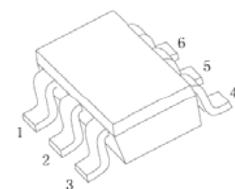
**GP8810L**

**20V Dual N-Channel MOSFET**

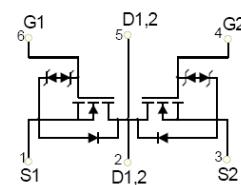
### Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
20V	12.2m $\Omega$ @10V	7A
	13.5m $\Omega$ @4.5V	
	14.6m $\Omega$ @3.8V	
	17.8m $\Omega$ @2.5V	

**SOT-23-6L**



**Schematic diagram**



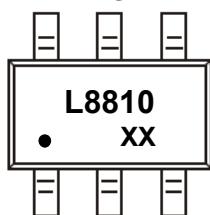
### Feature

- Trench Technology Power MOSFET
- Low  $R_{DS(ON)}$
- Low Gate Charge
- ESD Protected

### Application

- Load Switch
- DC/DC Converter

### MARKING:



L8810 = Device Code  
XX = Date Code  
Solid Dot = Pin1 Indicator

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

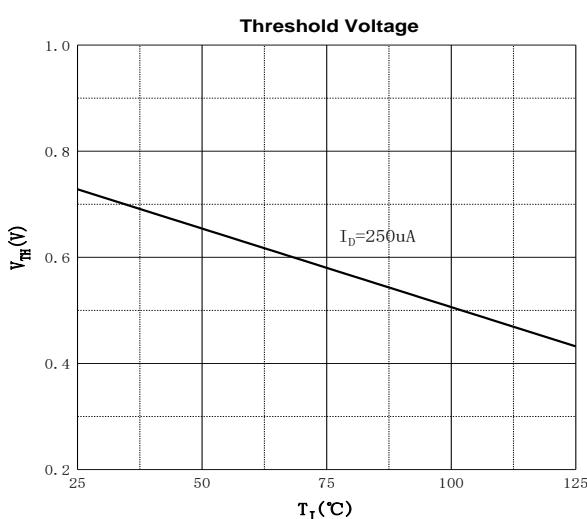
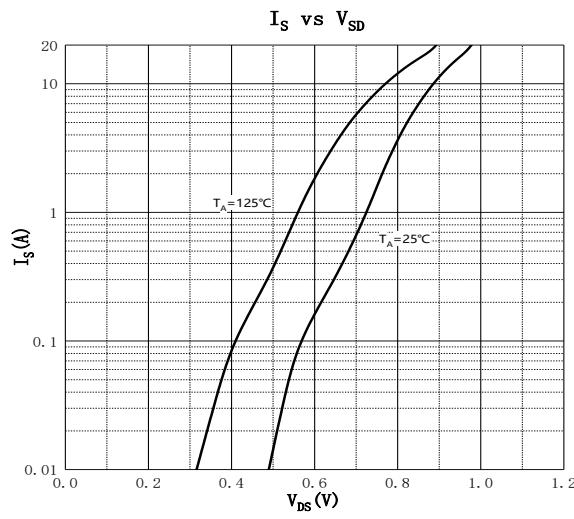
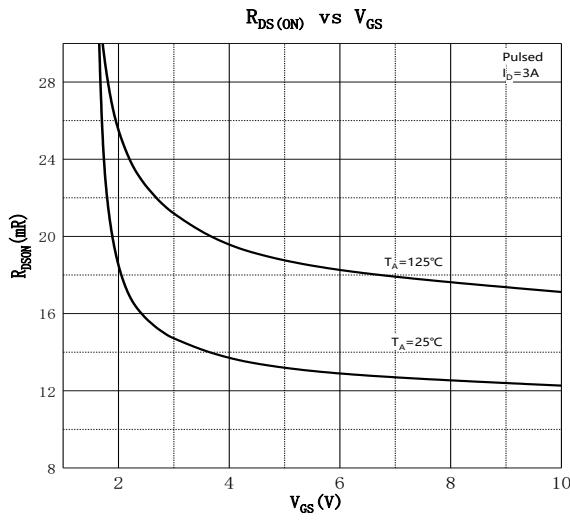
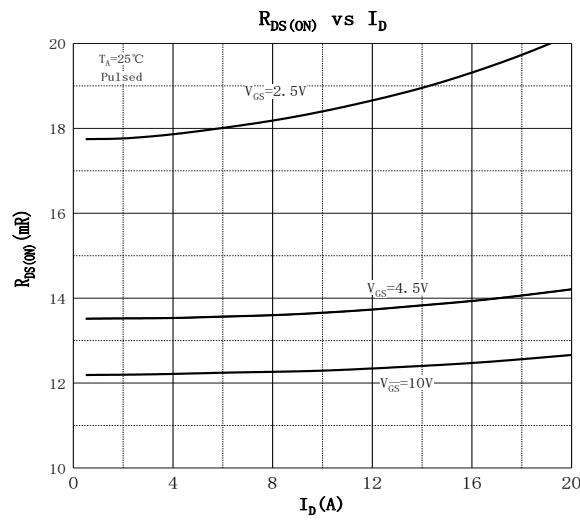
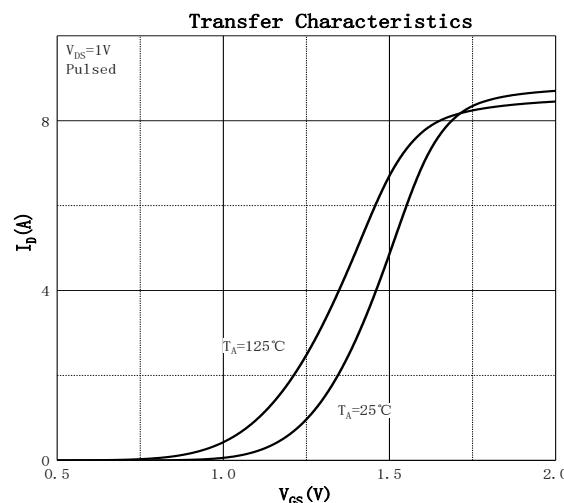
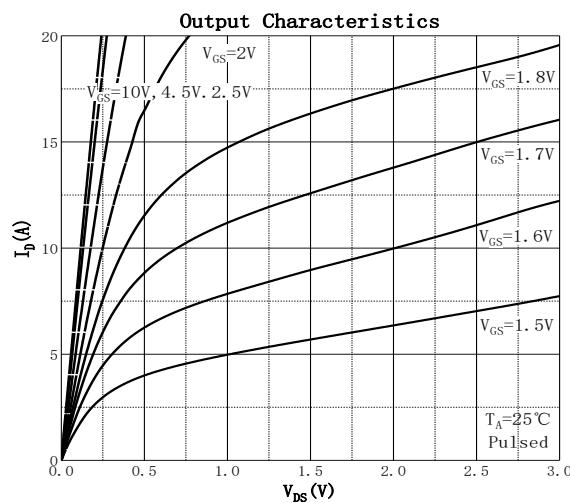
Parameter	Symbol	Value	Unit
Drain - Source Voltage	$V_{DS}$	20	V
Gate - Source Voltage	$V_{GS}$	$\pm 12$	V
Continuous Drain Current <sup>1,5</sup>	$I_D$	7	A
Pulsed Drain Current <sup>2</sup>	$I_{DM}$	28	A
Power Dissipation <sup>4,5</sup>	$P_D$	0.8	W
Thermal Resistance from Junction to Ambient <sup>5</sup>	$R_{\theta JA}$	156	$^\circ\text{C}/\text{W}$
Junction Temperature	$T_J$	150	$^\circ\text{C}$
Storage Temperature	$T_{STG}$	-55~+150	$^\circ\text{C}$

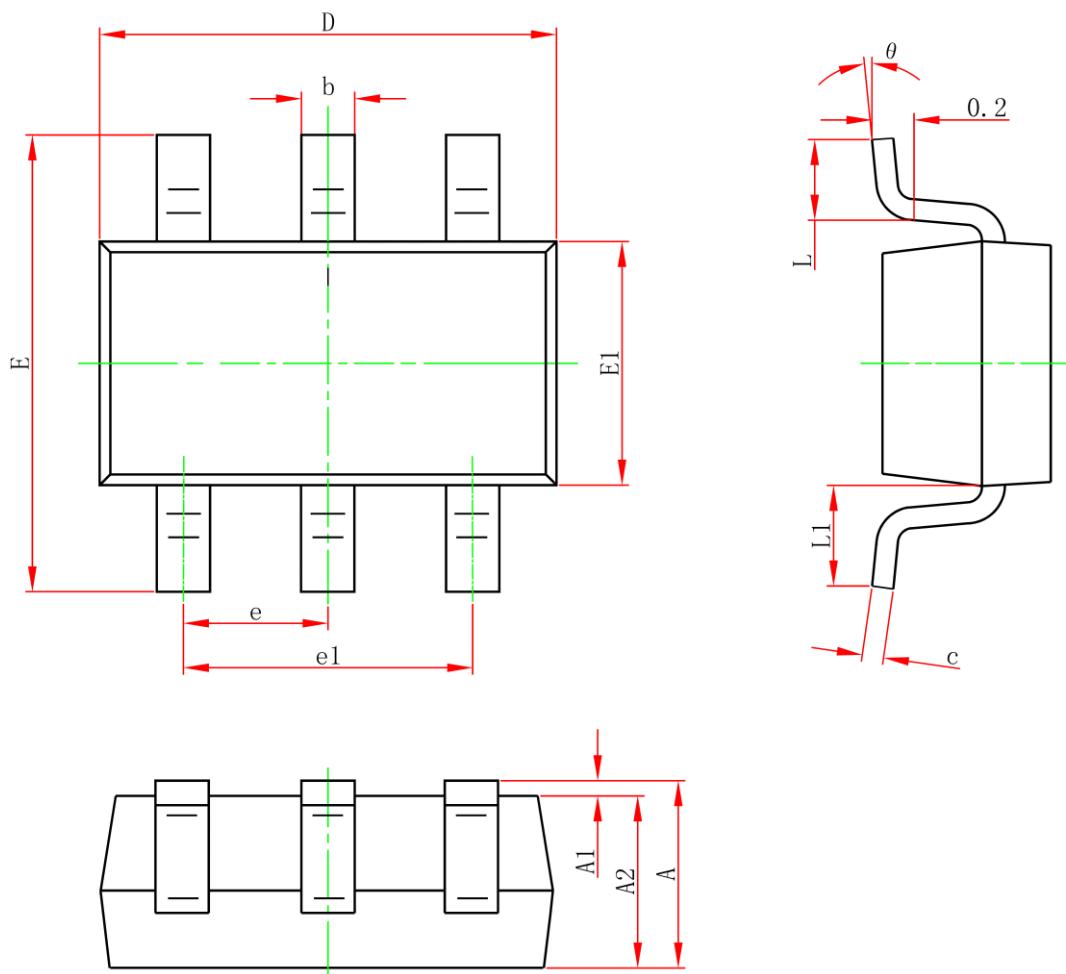
**MOSFET ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$  unless otherwise noted)**

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Off Characteristics</b>						
Drain - Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$	20			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{DS} = 16V, V_{GS} = 0V$			1	$\mu\text{A}$
Gate - Body Leakage Current	$I_{\text{GSS}}$	$V_{GS} = \pm 10V, V_{DS} = 0V$			$\pm 5$	$\mu\text{A}$
<b>On Characteristics<sup>3</sup></b>						
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	0.4	0.75	1	V
Drain-source On-resistance	$R_{DS(\text{on})}$	$V_{GS} = 10V, I_D = 3.0\text{A}$	10.5	12.2	18	$\text{m}\Omega$
		$V_{GS} = 4.5V, I_D = 3.0\text{A}$	11.5	13.5	20	
		$V_{GS} = 3.8V, I_D = 3.0\text{A}$	12.6	14.6	22	
		$V_{GS} = 2.5V, I_D = 3.0\text{A}$	14.5	17.8	26	
Forward transconductance	$g_{FS}$	$V_{DS} = 5V, I_D = 7\text{A}$	9			S
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 10V, V_{GS} = 0V, f = 1\text{MHz}$		567		pF
Output Capacitance	$C_{oss}$			117		
Reverse Transfer Capacitance	$C_{rss}$			109		
<b>Switching Characteristics</b>						
Total Gate Charge	$Q_g$	$V_{DS} = 10V, V_{GS} = 4.5V, I_D = 5\text{A}$		17		nC
Gate-source Charge	$Q_{gs}$			0.6		
Gate-drain Charge	$Q_{gd}$			4.3		
Turn-on Delay Time	$t_{d(\text{on})}$	$V_{DD} = 10V, V_{GS} = 4.5V,$ $R_L = 2\Omega, R_G = 3\Omega$		5		ns
Turn-on Rise Time	$t_r$			10		
Turn-off Delay Time	$t_{d(\text{off})}$			35		
Turn-off Fall Time	$t_f$			12		
<b>Source - Drain Diode Characteristics</b>						
Diode Forward Voltage <sup>3</sup>	$V_{SD}$	$V_{GS} = 0V, I_S = 1.0\text{A}$			1.2	V

Notes :

- 1.The maximum current rating is limited by package.
- 2.Pulse Test : Pulse Width  $\leq 10\mu\text{s}$ , duty cycle  $\leq 1\%$ .
- 3.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- 4.The power dissipation  $P_D$  is limited by  $T_{J(\text{MAX})} = 150^\circ\text{C}$ .
- 5.Device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ .

**Typical Characteristics**


**SOT-23-6L Package Information**


<b>Symbol</b>	<b>Dimensions In Millimeters</b>		<b>Dimensions In Inches</b>	
	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>
A	1.050	1.250	0.041	0.049
A1	0	0.150	0.000	0.006
A2	1.050	1.250	0.041	0.049
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	2.650	2.950	0.104	0.116
E1	1.500	1.700	0.059	0.067
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
L1	0.600REF		0.024REF	
theta	0°	8°	0°	8°